BC501 – Box PC for Industrial Applications

- AMD Embedded G-Series Dual-Core APU
- 2 Gigabit Ethernet
- 2 USB 2.0
- 2 DisplayPort® outputs, full HD with each display
- WLAN, GSM (2G), UMTS (3G), LTE (4G), GPS or GLONASS via 1 PCI Express® Mini Card slot
- 2 Slots for IBIS, GPS, RS232, RS485, RS422
- 1 CAN Bus interface optional
- 24 VDC nom. (16 to 36 V)
- -40 to +70°C operating temperature
- Fanless and maintenance-free design



The BC50I is a maintenance-free box computer that has been designed for independent use or as display computer electronics for use in industrial applications, e.g. for machine control, surveillance or commercial vehicles or robotics.

It is powered by an AMD Embedded G-Series APU (Accelerated Processing Unit), the T48N, running at 1.4 GHz. The G-Series combines low-power CPUs and advanced GPUs, in this case an AMD Radeon™ HD 6310, into a single embedded device.

The use of the Embedded G-Series makes for high scalability in CPU (single/dual core) and graphics performance (various Radeon™ GPUs or none at all). The BC50I is equipped with 2 GB of DDR3 SDRAM and offers SD card and mSATA slots. A SATA hard-disk/solid-state drive can be installed within the housing as an option.

The system is designed for fanless operation at temperatures from -40 to $+70^{\circ}$ C, its special aluminum housing with cooling fins serves as a heat sink for the

internal electronics and in this way provides conduction cooling.

The BC50I supports up to two DisplayPort® interfaces with a maximum resolution of 2560x1600 each. The DisplayPort® interfaces and all other I/O are available at the unit's front panel on standard connectors like USB, 9-pin D-Sub (optional serial I/O), RJ45 (Gigabit Ethernet) and DisplayPort®.

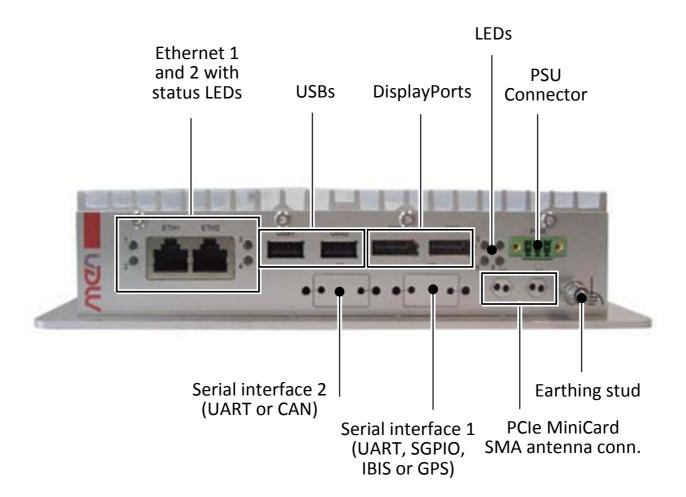
On the inside, the system offers one PCI Express® Mini card slot with a SIM card slot. The necessary antenna connectors can be made available at the front panel.

The BC50I comes with its own integrated 24 VDC nom. (16 to 36 V) power supply.

The combination of the various CPU/GPU options with the available selection of external interfaces (realized via separate graphics and I/O interface boards within the system) makes for an extremely flexible system design that can quickly be tailored to a vast number of applications.



Diagram



Technical Data

CPU	 AMD Embedded G-Series T48N Dual-Core 1.4 GHz processor core frequency 1066 MT/s DDR3 Speed Accelerated Processing Unit (APU), also includes GPU (see Graphics) 			
Controller Hub	■ AMD A55E			
Memory	 64 KB L1 and 512 KB L2 cache 2 GB DDR3 SDRAM system memory Soldered 			
Mass Storage	 One SD card slot Via USB One mSATA slot SATA Revision 3.x support Transfer rates up to 600 MB/s (6 Gbit/s) Serial ATA (SATA) One port for hard-disk/solid-state drive mounted within the unit's housing SATA Revision 3.x support Transfer rates up to 600 MB/s (6 Gbit/s) 			
Graphics	 ■ AMD Radeon™ HD 6310 □ Dual independent display support □ Dual DisplayPort® □ Maximum resolution: 2560x1600 □ Embedded in T48N APU ■ 3D Graphics Acceleration □ Full DirectX® 11 support, including full speed 32-bit floating point per component operations □ Shader Model 5 □ OpenCL™ 1.1 support □ OpenGL® 4.0 support ■ Motion Video Acceleration □ Dedicated hardware (UVD 3) for H.264, VC-1 and MPEG2 decoding □ HD HQV and SD HQV support: noise removal, detail enhancement, color enhancement, cadence detection, sharpness, and advanced de-interlacing □ Super up-conversion for SD to HD resolutions 			
Front I/O	 ■ 2 DisplayPort® 1.1a interfaces □ AUX channels and hot plug detection ■ 2 Gigabit Ethernet □ Via RJ45 connectors ■ 2 USB 2.0 □ Via Series A connector ■ 2 SA-Adapter™ slots for serial I/O □ RS232, RS485, RS422, IBIS or GPS possible on both slots □ SGPIO switchable by software on one slot □ CAN bus optional on one slot ■ 8 LEDs □ 4 for Ethernet link and activity status □ 2 user LEDs □ 1 status LED □ 1 power OK LED 			
1 PCI Express® Mini Card slot	 For functions such as Mobile service standards: GSM (2G), UMTS (3G), LTE (4G) and derivates Wireless communication: WLAN / WiFi IEEE 802.11 and derivates Positioning: GPS, GLONASS, GALILEO 1 SIM card slot PCI Express® and USB interface 			

Technical Data

Real-Time Clock	 Buffered by Gold Cap for up to 12 h 72 h as an option 		
Electrical Specifications	 Supply voltage: 24 VDC nom. (16 to 36 V) Run-down time after power-off Power consumption: up to 35 W (with PCI Express® Mini Card) 		
Mechanical Specifications	 Dimensions: approx. 250 mm x 220 mm x 44.1 mm Weight: 1.8 kg Front protected according to IP20 		
Environmental Specifications	 Temperature range (operation): -40°C to 70°C Fanless operation Temperature range (storage): -40+85°C Relative humidity (operation): max. 95% non-condensing Relative humidity (storage): max. 95% non-condensing Altitude: -300 m to +3,000 m Shock: 50 m/s², 30 ms Vibration (function): 1 m/s², 5 Hz - 150 Hz Vibration (lifetime): 7.9 m/s², 5 Hz - 150 Hz Conformal coating of internal components on request 		
MTBF	■ tbd @ 40°C according to IEC/TR 62380 (RDF 2000)		
Safety	■ PCB manufactured with a flammability rating of 94V-0 by UL recognized manufacturers		
EMC	■ Conforming to EN 55022 (radio disturbance), IEC 61000-4-2 (ESD) and IEC 61000-4-4 (burst)		
BIOS	■ InsydeH2O™ UEFI Framework		
Software Support	 Windows® 7 Windows® Embedded Standard 7 Windows® XP Embedded Linux 		

• For more information on supported operating system versions and drivers see Downloads.

Configuration & Options

Standard Configurations

Article No.	APU	Graphics	Memory	Input Voltage	Antenna Connectors	SATA HDD/SSD
09BC50I00	AMD T48N, 1.4 GHz Dual Core (18W)	AMD Radeon HD 6310	2 GB DDR3-1066, 64KB L1 cache, 512kB L2 cache	24 VDC nom.	No	No

Options

Options	
APU	 AMD T56N, 1.65 GHz Dual Core, 18W, AMD Radeon™ HD 6320 AMD T56E, 1.65 GHz Dual Core, 18W, AMD Radeon™ HD 6250 AMD T48N, 1.4 GHz Dual Core, 18W, AMD Radeon™ HD 6310 AMD T48E, 1.4 GHz Dual Core, 18W, AMD Radeon™ HD 6250 AMD T40N, 1.0 GHz Dual Core, 9W, AMD Radeon™ HD 6290 AMD T40E, 1.0 GHz Dual Core, 6.4W, AMD Radeon™ HD 6250 AMD T52R, 1.5 GHz Single Core, 18W, AMD Radeon™ HD 6310 AMD T44R, 1.2 GHz Single Core, 9W, AMD Radeon™ HD 6250 AMD T40R, 1.0 GHz Single Core, 5.5W, AMD Radeon™ HD 6250 AMD T16R, 615 MHz Single Core, 4.5W, AMD Radeon™ HD 6250 AMD T48L, 1.4 GHz Dual Core, 18W AMD T30L, 1.4 GHz Single Core, 18W AMD T24L, 1000 MHz Single Core, 5W
Memory	Up to 4 GB DDR3 SDRAM system memorySATA hard-disk/solid state drive (mounted within housing)
Graphics	 ■ Maximum resolution depending on GPU 2560x1600 (all DisplayPort® interfaces) with Radeon™ HD 6310 and 6320 1920x1200 (all DisplayPort® interfaces) with Radeon™ HD 6250 and 6290
I/O	 Antenna connectors For functions like Wi-Fi, WIMAX, GSM/GPRS, UMTS, LTE in combination with PCI Express[®] Mini Card Reverse SMA connector
Environmental Specifications	 Temperature range (operation): -40°C to 85°C (screened) with wider housing with additional cooling fins

As the product concept is very flexible, there are many other configuration possibilities. Please contact our sales team if you do not find your required function in the options. Please note that some of these options may only be available for large volumes.

Ordering Information

Standard BC50I Models	09BC50I00	Industrial box computer with dual graphics connection, 24 VDC PSU, AMD Dual Core T48N, 1.4 GHz, 2 GB RAM, SD card slot, mSATA slot, 2x DisplayPort®, 2x Gb Ethernet RJ45, 2x USB, 2x SA-Adapter™ slot (UARTs, fieldbuses), 1x PCI Express® Mini card slot, SIM card slot, -40+70°C screened	
Related Hardware	15PX01-00 GLONASS & GPS PCI Express® MiniCard (full size), 3-axis Gyro sensor, -40+85°C wit qualified components		
Memory	0751-0047	SD card, 4GB, -40+85°C	
	0751-0051	SSD mSATA, 8 GB, -40+85°C	
	0754-0007	SSD SATA 256 GB, 2.5" MLC, 0+70°C	
SA-Adapters™	08SA01-06	RS232, not optically isolated, -40+85°C screened	
	08SA02-07	RS422/485, full duplex, optically isolated, -40+85°C screened	
	08SA03-01	1 RS232, optically isolated, -40+85°C screened	
	08SA08-01	CAN ISO high-speed, optically isolated, -40+85°C screened	
	08SA15-00	8 digital I/O channels, -40+85°C with qualified components, no RoHS	
	08SA22-00	IBIS master SA-Adapter™, -40+85°C screened	
	08SA22-01	IBIS slave SA-Adapter™, -40+85°C screened	
Miscellaneous Accessories	05BC01-00	19" insertion frame for Box PCs including 2 heat sinks More info	
	0780-0005	DisplayPort® to DVI-D adapter, 20 cm	
	0780-0006	Active DisplayPort® (DP) to single link DVI-D adapter, 20cm, max. resolution 1920x1200, AMD / ATI Eyefinity technology	
	0781-0002	HF antenna cable with U.FL connector to RP-SMA connector, 200 mm	
	0799-0003	UMTS PCIe® Mini Card GTM661W, half-size card with adapter for full-size slot, -10° C+55°C operating temperature, -40°C+85°C storage temperature Note: when using wireless modules the R&TTE Guide of the EU has to be observed. See the R&TTE website For the module's driver see Option's website WLAN PCIe® MiniCard 6205, 802.11n 2x2 MIMO, 2.4 GHz and 5 GHz, half-size card	
		with adapter for full-size slot, operating temperature 0°C+80°C, storage temperature -40°+85°C Note: when using wireless modules the R&TTE Guide of the EU has to be observed. See the R&TTE website For the module's driver see Intel®'s website	

Ordering Information

Software: Linux	This product is de from MEN.	signed to work under Linux. See below for potentially available separate software packages
	13SC24-90	Linux I2C controller driver (MEN) for SC24, AE51, BC50M, BC50I and BL50W
	13Y004-06	MDIS5™ low-level driver sources (MEN) for generic SMBus driver for F14, F15, F17, F18, F19P, F21P, F22P, G20, G22, D9, D601, F600 and F601, A19, A20, F217, SC24, BC50M, BC50I and BL50W
	13Z010-06	MDIS4 [™] /2004 / MDIS5 [™] low-level driver sources (MEN) for 16Z076_QSPI
	13Z015-06	MDIS5™ low-level driver sources (MEN) for 16Z029_CAN (MSCAN/Layer2)
	13Z016-06	MDIS5™ driver (MEN) for 16Z029_CAN (CANopen master)
	13Z017-06	MDIS5™ low-level driver sources (MEN) for 16Z034_GPIO, 16Z037_GPIO and 16Z127_GPIO
Software: Windows®	This product is de packages from MI	signed to work under Windows®. See below for potentially available separate software EN.
	10F014-78	Windows® XP Embedded BSP (MEN) for F11S, F14, F15, F17, F18, F19P, F21P, G20, XM1, XM1L, XM2, MM1, MM2, SC21, SC24, DC1, DC2, RC1, BC50I, BC50M and BL50W
	10Y000-78	Windows® Embedded Standard 7 BSP for F11S, F19P, F21P, F22P, G20, G22, XM1L, XM2, MM1, MM2, SC21, SC24, SC27, BC50M, BC50I, BL50W, BL50S, F206, F210, F215, F216, G215, P506, P507 and P511
	13SC24-77	Windows® Installset (MEN) for SC24, BC50M, BC50I and BL50W (Includes all free drivers developed by MEN for the supported hardware.)
	13T010-70	Windows® 32-bit network driver (Intel®) for XM1, XM1L, XM2, MM2, F11S, F18, F18E, F19P, F21P, F22P, G20, G22, GM1, GM2, G211, G211F, SC24, BC50I, BC50M and BL50W
	13T020-70	Windows® 64-bit network driver (Intel®) for F18, F18E, F19P, F21P, F22P, G20, G22, GM1, GM2, G211, G211F, XM2, SC24, BC50I, BC50M and BL50W
	13T025-70	Windows® XP GPU and chipset driver (AMD) for BC50M, BC50I, BL50W and SC24
	13T026-70	Windows® Vista™ / Windows® 7 GPU and chipset driver (AMD) for BC50M, BC50I, BL50W, SC24 and G214
	13Z010-70	MDIS5™ Windows® driver (MEN) for 16Z076_QSPI devices
	13Z015-70	MDIS4 [™] /2004 / MDIS5 [™] Windows [®] driver (MEN) for 16Z029_CAN (MSCAN/Layer2)
	13Z016-70	MDIS5™ Windows® driver (MEN) for 16Z029_CAN (CANopen master)
	13Z017-70	MDIS4 [™] /2004 / MDIS5 [™] Windows [®] driver (MEN) for 16Z034_GPIO devices

For operating systems not mentioned here contact MEN sales.

Documentation	Compare Chart Standard and Custom Box PCs » Download		
	20BC50IER	BC50I Errata	
	20BC50I00	BC50I User Manual	

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